

ETR0308 007a

High Speed LDO Regulators, Low ESR Cap. Compatible, Ultra Small Package

■GENERAL DESCRIPTION

The XC6213 series is a highly precise positive voltage LDO regulator with low noise manufactured using CMOS process. The series achieves high ripple rejection and low dropout and consists of a voltage reference, an error amplifier, a current limiter and a phase compensation circuit plus a driver transistor. Output voltage is selectable in 0.05V increments within a range of 1.2V to 5.0V. The series is also compatible with low ESR ceramic capacitors, which give output stability. The current limiter's foldback circuit also operates as a short circuit protection for the output pin. The CE function enables the output to be turned off, resulting in greatly reduced power consumption. Ultra small package SSOT-24, SOT-25, USPN-4 and USP-4 are available.

APPLICATIONS

- Mobile phones
- Cordless phones,

Wireless communication equipment

- Portable games
- Cameras, Video recorders
- Portable AV equipment
- **●**PDAs

■FEATURES

Maximum Output Current : 150mA @ Vo∪T=3.0V, VIN=4.0V

Dropout Voltage : 400mV @ louT = 100mA

Input Voltage Range : 2.0 ~ 6.0V

Output Voltage Range : 1.2 ~ 5.0V (0.05V Increments)

Highly Accurate : $\pm 2\%$

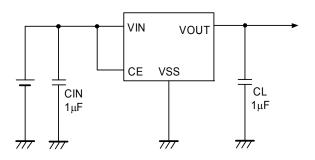
Packages : SSOT-24

SOT-25 USP-4 USPN-4

Environmentally Friendly : EU RoHS Compliant, Pb Free

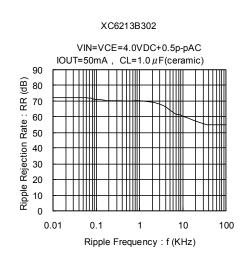
■TYPICAL APPLICATION CIRCUIT

●SSOT-24 package

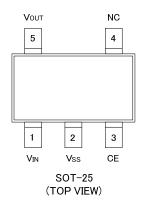


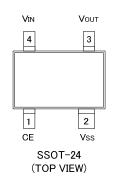
■TYPICAL PERFORMANCE CHARACTERI STICS

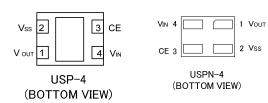
Ripple Rejection Rate vs. Ripple Frequency



■PIN CONFIGURATION







*The dissipation pad for the USP-4 package should be solder-plated in recommended mount pattern and metal masking so as to enhance mounting strength and heat release. If the pad needs to be connected to other pins, it should be connected to the Vss (No. 2) pin

■PIN ASSIGNMENT

	PIN NU	JMBER	PIN NAME FUNCTION			
SOT-25	SSOT-24	USP-4	USPN-4	FIN NAIVIE	FUNCTION	
1	4	4	4	VIN	Power Supply	
2	2	2	2	VSS	Ground	
3	1	3	3	CE	On / Off Switch	
4	-	1	-	NC	No Connection	
5	3	1	1	VOUT	Output	

■PRODUCT CLASSIFICATION

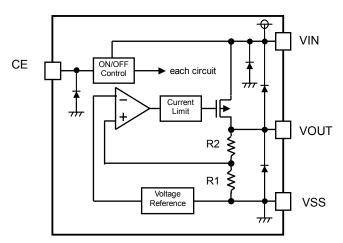
Ordering Information

XC6213(1)(2)(3)(4)(5)(6)-(7)(*1)

DESIGNATOR	ITEM	SYMBOL	DESCRIPTION			
1)	Type of Regulator	В	High Active with no pull-down resistor (standard)			
23	3 Output Voltage 12~50		Output Voltage: ex.) 3.0V→ ② =3, ③= 0			
	Output Voltage	2	0.1V increments, $\pm 2\%$ accuracy ex.) 2.80V \rightarrow ②=2, ③= 8, ④= 2			
4)	4 Accuracy		0.05V increments, $\pm 2\%$ accuracy ex.) 2.85V \rightarrow 2=2, 3=8, 4=			
		MR	SOT-25 (3,000/Reel)			
		MR-G	SOT-25 (3,000/Reel)			
	5 .	NR	SSOT-24 (3,000/Reel)			
56-7	Package	NR-G	SSOT-24 (3,000/Reel)			
	(Oder Unit)	GR	USP-4 (3,000/Reel)			
		GR-G	USP-4 (3,000/Reel)			
		7 R-G	USPN-4 (5,000/Reel)			

The "-G" suffix indicates that the products are Halogen and Antimony free as well as being fully RoHS compliant.

■BLOCK DIAGRAM



^{*}Diode inside the circuit is a protection diode.

■ ABSOLUTE MAXIMUM RATINGS

Ta = 25°C

PARAMETER		SYMBOL	RATINGS	UNITS
Input Vo	ltage	Vin	Vss - 0.3 ~ 7.0	V
Output C	urrent	lout	500 (*1)	mA
Output Vo	oltage	Vout	$Vss - 0.3 \sim Vin + 0.3$	V
CE Input \	/oltage	VCE	Vss - 0.3 ~ 7.0	V
	SOT-25		250	
	501-25		600(PCB mounted)(*2)	
	SSOT-24		150	
Dower Dissinction		D-I	500(PCB mounted)(*2)	mW
Power Dissipation	USP-4	Pd	120	IIIVV
	USP-4		1000(PCB mounted)(*2)	
	LICON 4		100	
	USPN-4		600(PCB mounted)(*2)	
Operating Ambien	t Temperature	Topr	- 40 ~ + 85	္လ
Storage Temper	ature Range	Tstg	- 55 ~ + 125	°C

^{*1:} IOUT=Pd/(VIN-VOUT)

^{*2:} The power dissipation figure shown is PCB mounted. Please refer to pages 29 to 32 for details.

■ELECTRICAL CHARACTERISTICS

●XC6213B series Ta=25°C

DADAMETED	0)/1/1001	COMPITIONS	NAIN!	T\/D	MAN		OIDOLUTO
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUITS
Output Voltage	VOUT(E)	IOUT=30mA, CE=VIN	VOUT(T) x 0.98	Vout(t)	VOUT(T) x 1.02	٧	1
		VIN=VOUT(T)+1.0V, VOUT(T)=1.20~1.45V, CE=VIN	100	-	-		
Maximum Outrut Ourset	louzuv	VIN=VOUT(T)+1.0V, VOUT(T)=1.50~2.95V, CE=VIN	120	-	-	A	1)
Maximum Output Current	IOUTMAX	VIN=VOUT(T)+1.0V, VOUT(T)=3.00~4.05V, CE=VIN	150	-	-	mA	U
		VIN=VOUT(T)+1.0V, VOUT(T)=4.10~5.00V, CE=VIN	200	-	-		
Load Regulation	∆Vо∪т	VIN=VOUT(T)+1.0V, 1mA≦IOUT≦100mA, CE=VIN	-	15	50	mV	1
	Vdif1	IOUT = 30mA, CE=VIN	E-1		mV	1	
Dropout Voltage	Vdif2	IOUT=100mA, CE=VIN		E-2			1
Supply Current	Iss	VIN=VOUT(T)+1.0V, CE=VIN	25	35	50	μΑ	2
Stand-by Current	Istby	VIN=VOUT(T)+1.0V~6.0V, CE=Vss	-	0.01	0.10	μΑ	2
Line Regulation	$\frac{\Delta V \text{OUT}}{\Delta V \text{IN} \cdot V \text{OUT}}$	Vout(t)+1.0V≦VIN≦6V Iout=30mA, CE=VIN	-	0.01	0.20	%/V	1
Input Voltage	VIN	-	2.0	-	6.0	V	-
Output Voltage Temperature Characteristics	ΔVουτ ΔTopr · Vout	Iout=30mA, CE=ViN - 40°C≦Topr≦85°C	-	±100	-	ppm/°C	1
Ripple Rejection Rate	PSRR	VIN=[VOUT(T)+1.0 V] +0.5Vp-pAC IOUT=50mA, f=10kHz, CE=VIN	-	60	-	dB	3
Short Circuit Current	Ishort	VIN=VOUT(T) + 1.0V, CE=VIN	-	50	-	mA	1
CE 'H' Level Voltage	VCEH		1.3	-	6.0	V	1
CE 'L' Level Voltage	VCEL	-	-	-	0.25	V	2
CE 'H' Level Current	Ісен	VCE = VIN=VOUT(T) + 1.0V	- 0.1	-	0.1	μΑ	2
CE 'L' Level Current	ICEL	VIN=VOUT(T) +1.0V, VCE =VSS	- 0.1	-	0.1	μΑ	2

NOTE:

- *1: VOUT(T): Setting output voltage
- *2: Vout(E) = Effective output voltage
 (i.e. the output voltage when "Vout (T) + 1.0V" is provided at the VIN pin while maintaining a certain lout value).
- *3: Vdif = { VIN1 (*5) VOUT1 (*4)}
- *4: Vout1 = A voltage equal to 98% of the output voltage whenever an amply stabilized IOUT { Vout(T) + 1.0V } is input.
- *5: VIN1 = The input voltage when Vout1 appears as input voltage is gradually decreased.
- *6: Unless otherwise stated, (VIN = VOUT(T) + 1.0V).
- *7: $VOUT(T) \le 1.45V = Minimum: VOUT(T)-30mV, Maximum: VOUT(T)+30mV$

■ ELECTRICAL CHARACTERISTICS (Continued)

● Dropout Voltage Chart

Ta=25°C

Ta=25°C							
SYMBOL	E-0			-1	E	-2	
SETTING	OUTPUT VOLTAGE		DROPOUT VOLTAGE 1		DROPTOUT VOLTAGE 2		
VOLTAGE	(V)	Iout=30	mA (mV)	Iout=100	mA (mV)	
	Vo	DUT	Vdif1	Vdif1	Vdif2	Vdif2	
Vout(t)	MIN.	MAX.	TYP.	MAX.	TYP.	MAX.	
1.20	1.170	1.230	760	800	850	1000	
1.25	1.220	1.280	760	800	850	1000	
1.30	1.270	1.330	660	700	810	960	
1.35	1.320	1.380	660	700	810	960	
1.40	1.370	1.430	560	600	770	920	
1.45	1.420	1.480	560	600	770	920	
1.50	1.470	1.530	460	500	730	880	
1.55	1.519	1.581	460	500	730	880	
1.60	1.568	1.632	360	400	690	840	
1.65	1.617	1.683	360	400	690	840	
1.70	1.666	1.734	260	300	650	800	
1.75	1.715	1.785	260	300	650	800	
1.80	1.764	1.836	200	240	600	750	
1.85	1.813	1.887	200	240	600	750	
1.90	1.862	1.938	200	240	600	750	
1.95	1.911	1.989	200	240	600	750	
2.00	1.960	2.040	190	230	530	670	
2.05	2.009	2.091	190	230	530	670	
2.10	2.058	2.142	190	230	530	670	
2.15	2.107	2.193	190	230	530	670	
2.20	2.156	2.244	190	230	530	670	
2.25	2.205	2.295	190	230	530	670	
2.30	2.254	2.346	190	230	530	670	
2.35	2.303	2.397	190	230	530	670	
2.40	2.352	2.448	190	230	530	670	
2.45	2.401	2.499	190	230	530	670	
2.50	2.450	2.550	180	210	470	580	
2.55	2.499	2.601	180	210	470	580	
2.60	2.548	2.652	180	210	470	580	
2.65	2.597	2.703	180	210	470	580	
2.70	2.646	2.754	180	210	470	580	
2.75	2.695	2.805	180	210	470	580	
2.80	2.744	2.856	180	210	470	580	
2.85	2.793	2.907	180	210	470	580	
2.90	2.842	2.958	180	210	470	580	
2.95	2.891	3.009	180	210	470	580	
3.00	2.940	3.060	150	180	400	500	
3.05	2.989	3.111	150	180	400	500	
3.10	3.038	3.162	150	180	400	500	
3.15	3.087	3.213	150	180	400	500	
3.20	3.136	3.264	150	180	400	500	
3.25	3.185	3.315	150	180	400	500	
3.30	3.234	3.366	150	180	400	500	
3.35	2.283	3.417	150	180	400	500	
3.40	2.332	3.468	150	180	400	500	
3.45	3.381	3.519	150	180	400	500	

■ ELECTRICAL CHARACTERISTICS (Continued)

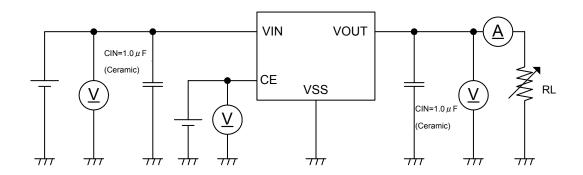
● Dropout Voltage Chart (Continued)

Ta=25°C

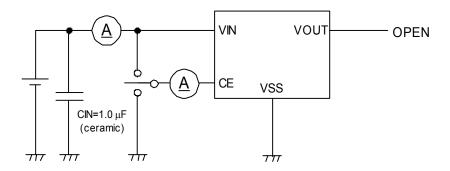
	Ta=25°C							
SYMBOL	Е	-0	_	E-1		-2		
SETTING	OUTPUT VOLTAGE		DROPOUT VOLTAGE 1		DROPTOUT VOLTAGE 2			
VOLTAGE	(V)		Iout=30	mA (mV)	Iout=100mA (mV)			
)/OUT(T)	Vo	DUT	Vdif1	Vdif1	Vdif2	Vdif2		
Vout(t)	MIN.	MAX.	TYP.	MAX.	TYP.	MAX.		
3.50	3.430	3.570	140	170	350	450		
3.55	3.479	3.621	140	170	350	450		
3.60	3.528	3.672	140	170	350	450		
3.65	3.577	3.723	140	170	350	450		
3.70	3.626	3.774	140	170	350	450		
3.75	3.675	3.825	140	170	350	450		
3.80	3.724	3.876	140	170	350	450		
3.85	3.773	3.927	140	170	350	450		
3.90	3.822	3.978	140	170	350	450		
3.95	3.871	4.029	140	170	350	450		
4.00	3.920	4.080	130	160	320	420		
4.05	3.969	4.131	130	160	320	420		
4.10	4.018	4.182	130	160	320	420		
4.15	4.067	4.233	130	160	320	420		
4.20	4.116	4.284	130	160	320	420		
4.25	4.165	4.335	130	160	320	420		
4.30	4.214	4.386	130	160	320	420		
4.35	4.263	4.437	130	160	320	420		
4.40	4.312	4.488	130	160	320	420		
4.45	4.361	4.539	130	160	320	420		
4.50	4.410	4.590	120	150	300	400		
4.55	4.459	4.641	120	150	300	400		
4.60	4.508	4.692	120	150	300	400		
4.65	4.557	4.743	120	150	300	400		
4.70	4.606	4.794	120	150	300	400		
4.75	4.655	4.845	120	150	300	400		
4.80	4.704	7.896	120	150	300	400		
4.85	4.753	4.947	120	150	300	400		
4.90	4.802	4.998	120	150	300	400		
4.95	4.851	5.049	120	150	300	400		
5.00	4.900	5.100	120	150	300	400		

■TEST CIRCUITS

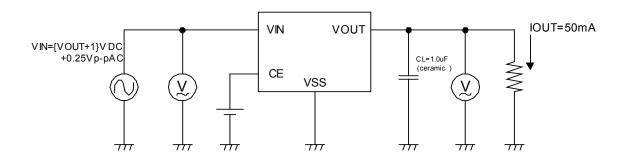
●Circuit ①



●Circuit ②



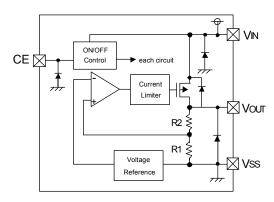
●Circuit ③



■OPERATIONAL EXPLANATION

<Output Voltage Regulator Control>

The voltage, divided by resistors R1 & R2, which are connected to the Vout pin is compared with the internal reference voltage by the error amplifier. The P-channel MOSFET which is connected to the Vout pin is then driven by the subsequent output signal. The output voltage at the Vout pin is controlled & stabilized by negative feedback. The current limit circuit and short circuit protection operate in relation to the level of output current. Further, the voltage regulator's internal circuitry can be shutdown via the CE pin's signal.

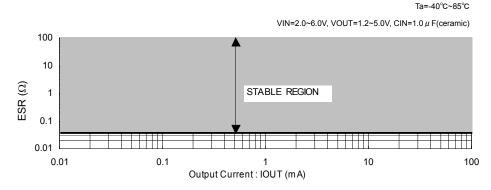


<Low ESR Capacitor>

With the XC6213 series regulator, a stable output voltage is achievable even if low ESR capacitors are used, as a phase compensation circuit is built-in to the regulator. In order to ensure the effectiveness of the phase compensation, please connect an output capacitor (CL) with a capacitance, based on the chart below. The equivalent serial resistor (ESR) of the output capacitor (ESR) should be within the range as the graph below shown. We also suggest an input capacitor (ESR) of 1.0 μ F: this should be connected between VIN and Vss in order to stabilize input power source.

Output Capacitor Corresponding Chart

SETTING VOLTAGE	1.2 ~ 1.75V	1.8 ~ 5.0V
CL	More than 3.3μ F	More than 1.0 μ F



<Short-Circuit Protection>

The XC6213 series regulator offers circuit protection by means of a built-in foldback circuit. When the load current reaches the current limit level, the fixed current limiter circuit operates and output voltage drops. As a result of this drop in output voltage, the foldback circuit operates, the output voltage drops further and output current decreases. When the output pin is shorted, a current of about 50mA flows.

<CE Pin>

The IC's internal regulator circuitry can be shut down via the signal from the CE pin with the XC6213 series. In shutdown mode, output at the Vout pin will be pulled down to the Vss level. Note that as the XC6213B types are 'High Active / No Pull-Down', operations will become unstable with the CE pin open. We suggest that you use this IC with either a VIN voltage or a Vss voltage input at the CE pin. If this IC is used with the correct specifications for the CE pin, the IC will operate normally. However, supply current may increase as a result of through current in the IC's internal circuitry if a voltage other than VIN or Vss is applied.

<Minimum Operating Voltage>

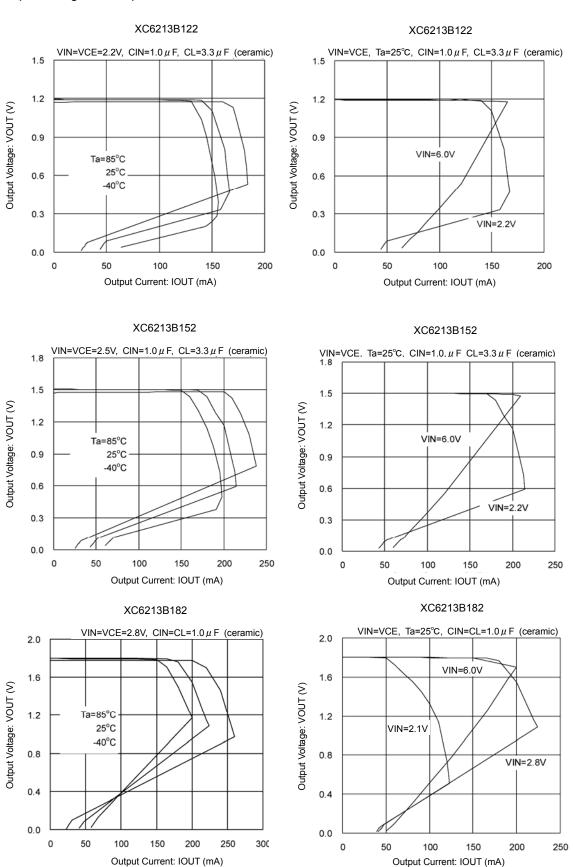
Please apply input voltage more than 2.0V or more in order to stabilize the operation of the IC's. Normal output voltage may not be obtained when the input voltage is lower than 2.0V.

■NOTES ON USE

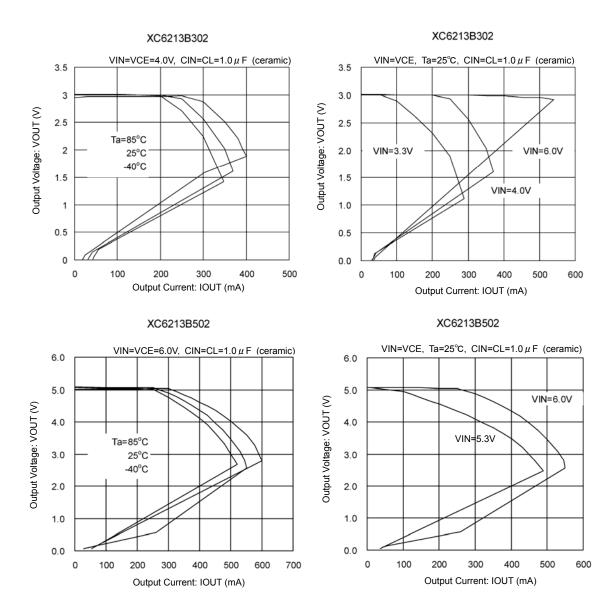
- 1. Please use this IC within the stated absolute maximum ratings. The IC is liable to malfunction should the ratings be exceeded.
- 2. Where wiring impedance is high, operations may become unstable due to noise and/or phase lag depending on output current. Please strengthen V_{IN} and V_{SS} wiring in particular.
- 3. Please wire the input capacitor (C_{IN}) and the output capacitor (C_{L}) as close to the IC as possible. Should rapid input fluctuation or load fluctuation occur, please increase the capacitor value such as C_{IN} or CL to stabilize the operation.
- 4. Make sure not to use the IC with large current at high temperature. When exceeding power dissipation of a package, heat occurs before short protection operates, and the IC may break.

■TYPICAL PERFORMANCE CHARACTERISTICS

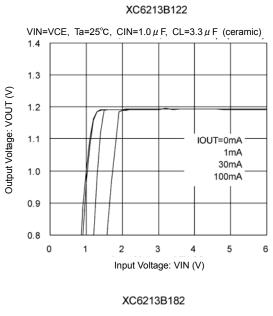
(1) Output Voltage vs. Output Current

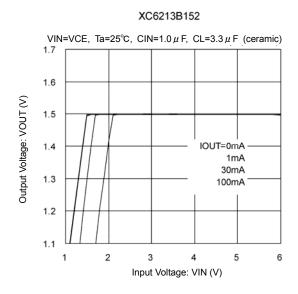


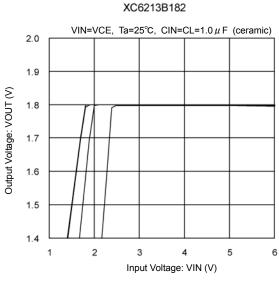
(1) Output Voltage vs. Output Current (Continued)

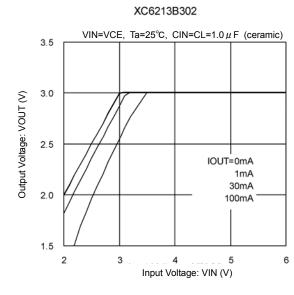


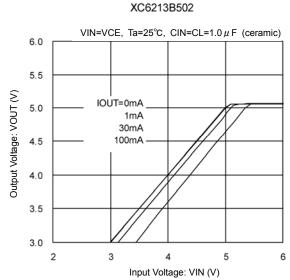
(2) Output Voltage vs. Input Voltage











(3) Dropout Voltage vs. Output Current

25°C

-40°C

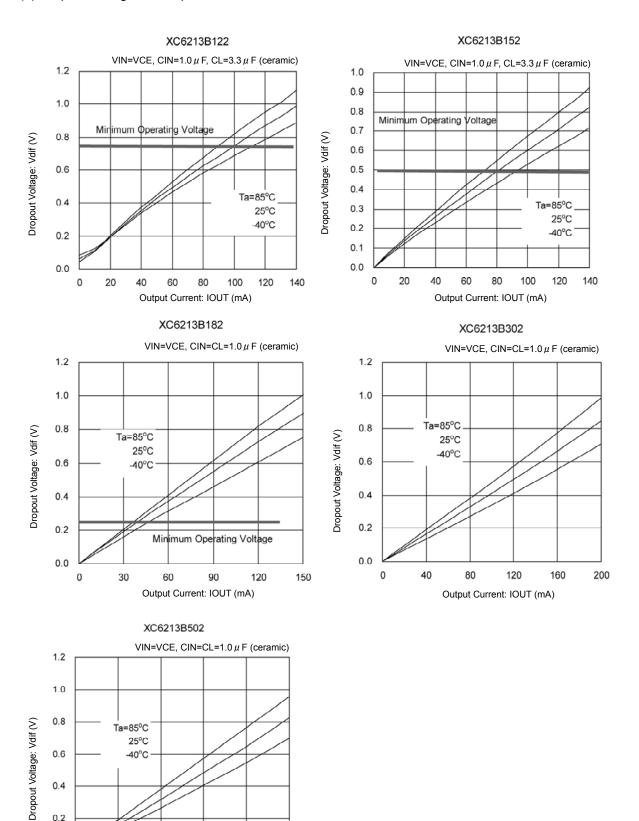
50

100

150 Output Current: IOUT (mA)

200

250



0.6

0.4

0.2

0.0

(4) Supply Current vs. Input Voltage

5 | 0

1

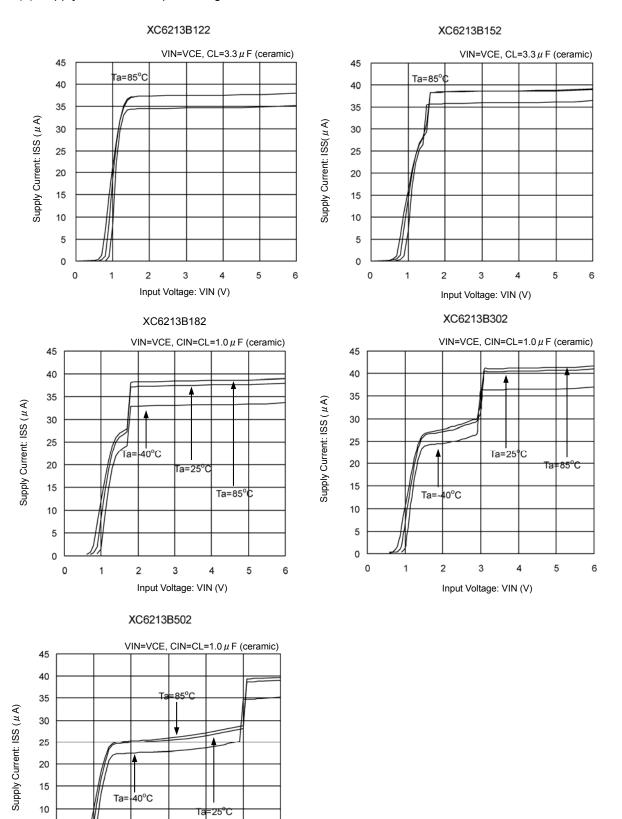
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Input Voltage: VIN (V)

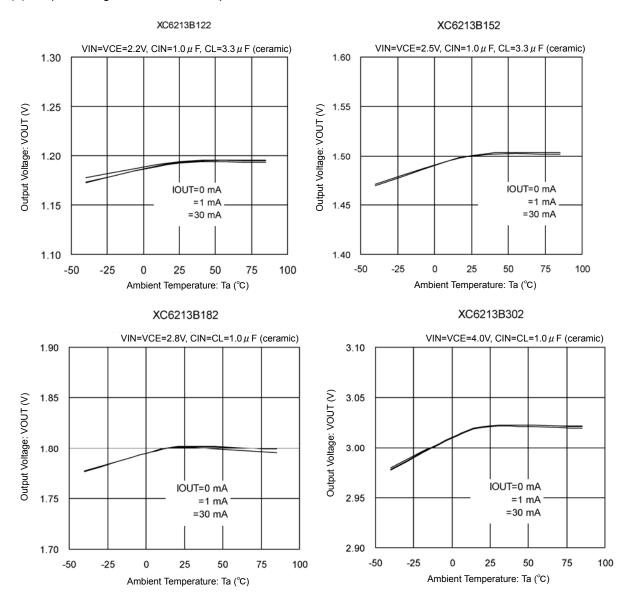
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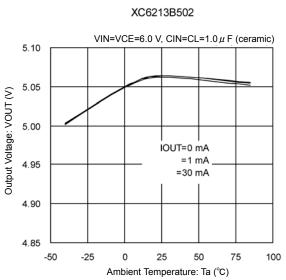
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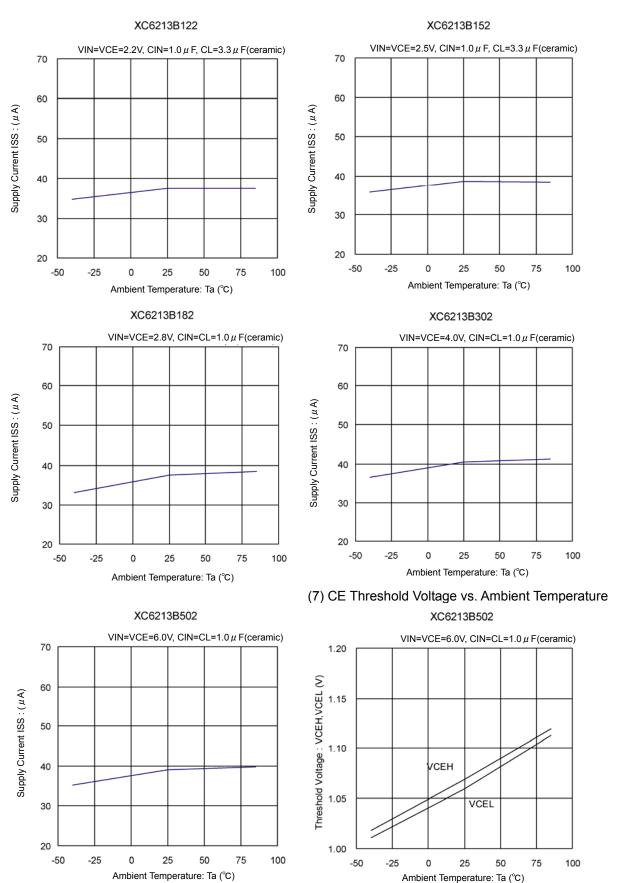


(5) Output Voltage vs. Ambient Temperature



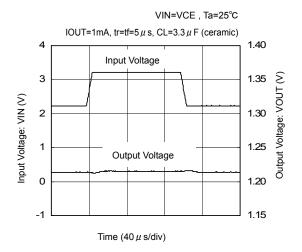


(6) Supply Current vs. Ambient Temperature

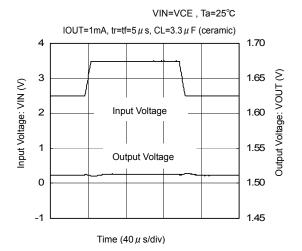


(8) Input Transient Response

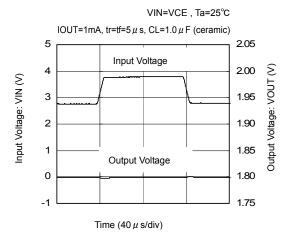
XC6213 B122



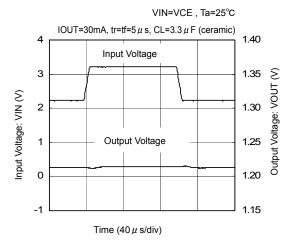
XC6213 B152



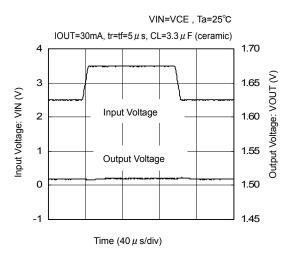
XC6213 B182



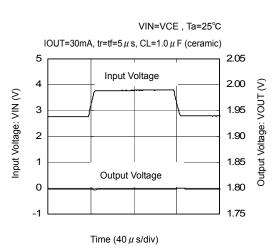
XC6213 B122



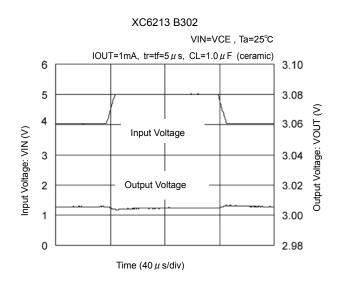
XC6213 B152

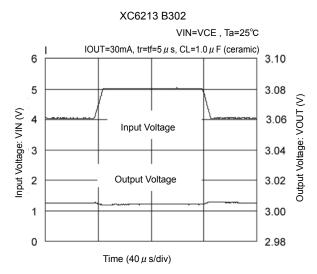


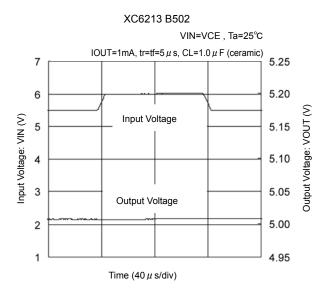
XC6213 B182

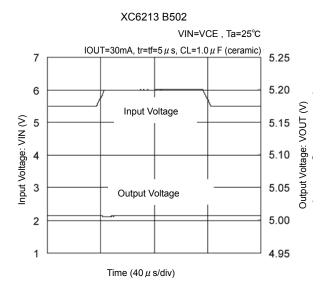


(8) Input Transient Response (continued)



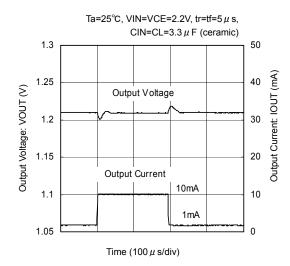




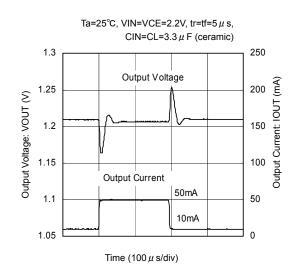


(9) Load Transient Response

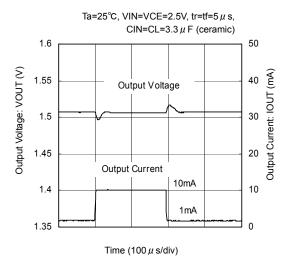
XC6213 B122



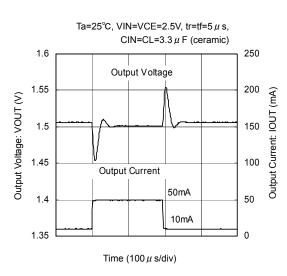
XC6213 B122



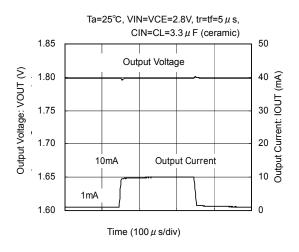
XC6213 B152



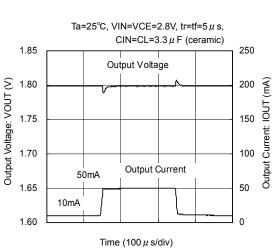
XC6213 B152



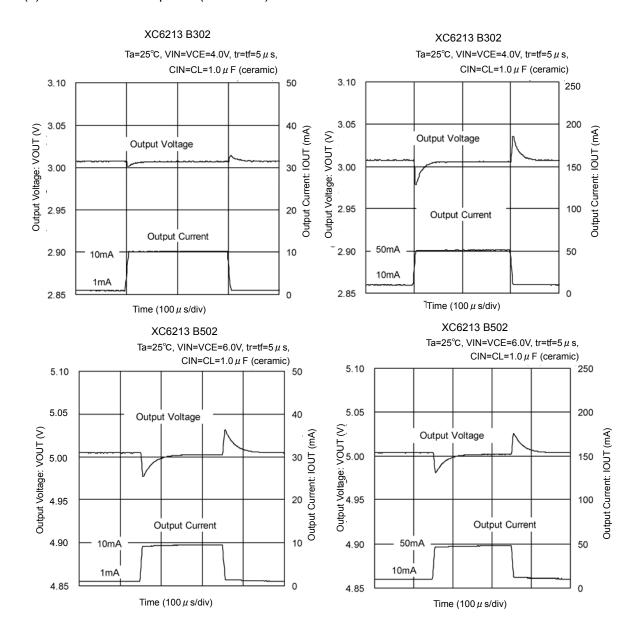
XC6213 B182



XC6213 B182

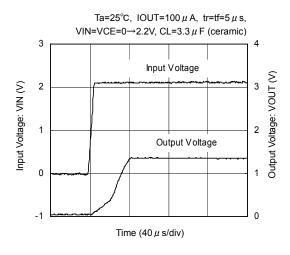


(9) Load Transient Response (Continued)



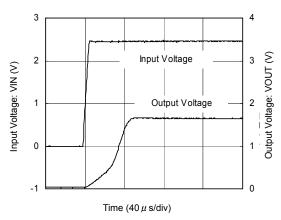
(10) Turn-On Response



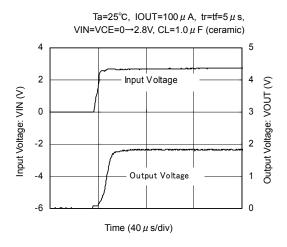


XC6213 B152

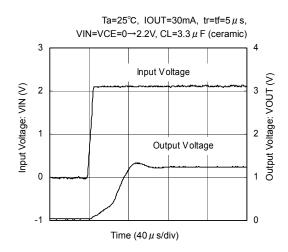
Ta=25°C, IOUT=100 μ A, tr=tf=5 μ s, VIN=VCE=0 \rightarrow 2.5V, CL=3.3 μ F (ceramic)



XC6213 B182

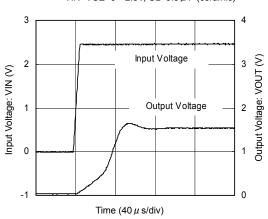


XC6213 B122



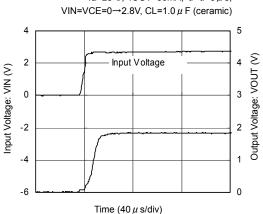
XC6213 B152

Ta=25°C, IOUT=30mA, tr=tf=5 μ s, VIN=VCE=0 \rightarrow 2.5V, CL=3.3 μ F (ceramic)

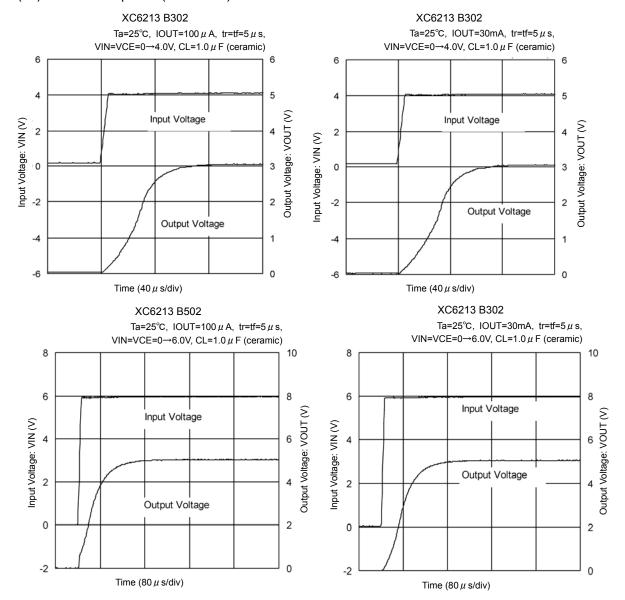


XC6213 B182

Ta=25°C, IOUT=30mA, tr=tf=5 μ s,

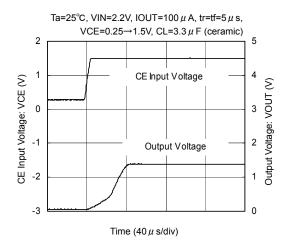


(10) Turn-On Response (Continued)

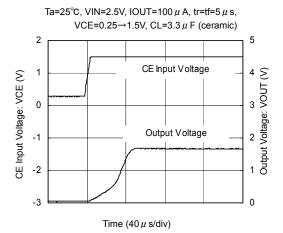


(11) Enable Response

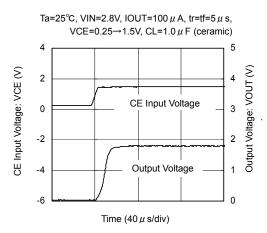




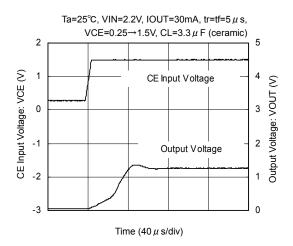
XC6213 B152



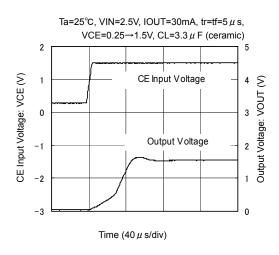
XC6213 B182



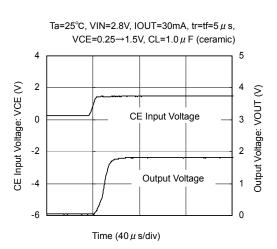
XC6213 B122



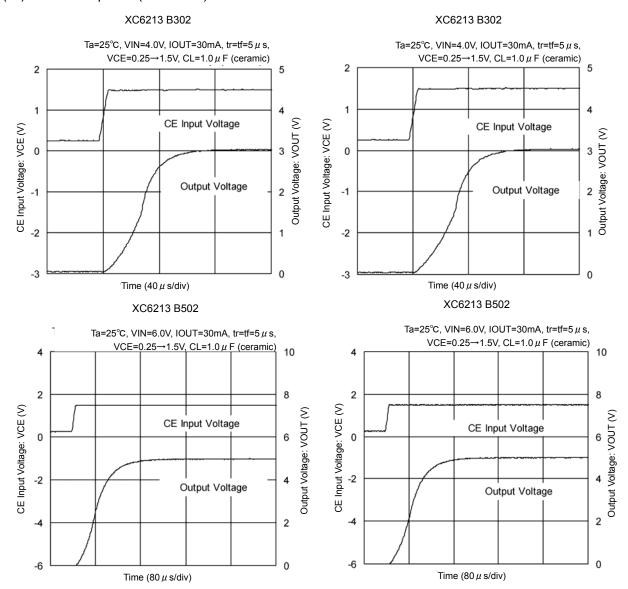
XC6213 B152



XC6213 B182



(11) Enable Response (Continued)

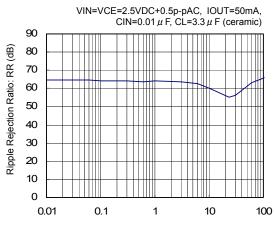


(12) Ripple Rejection Rate

XC6213 B122

VIN=VCE=2.2VDC+0.5p-pAC, IOUT=50mA, CIN=0.01 μ F, CL=3.3 μ F (ceramic) 90 80 (gB) RR 70 Ripple Rejection Ratio: 60 50 40 30 20 10 0.01 0.1 1 10 100

XC6213 B152



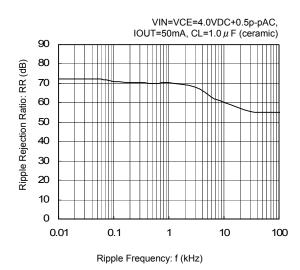
Ripple Frequency: f (kHz)

XC6213 B182

Ripple Frequency: f (kHz)

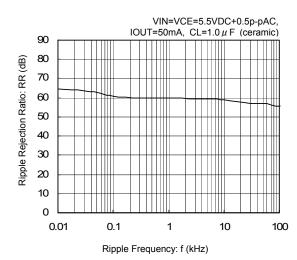
VIN=VCE=2.8VDC+0.5p-pAC, IOUT=50mA, CL=1.0 μ F (ceramic) 90 80 Ripple Rejection Ratio: RR (dB) 70 60 50 40 30 20 10 0 0.01 0.1 1 10 100

XC6213 B302



XC6213 B502

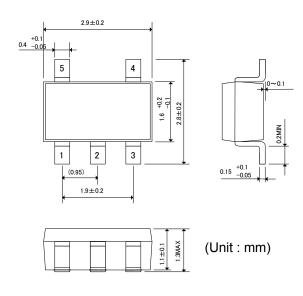
Ripple Frequency: f (kHz)

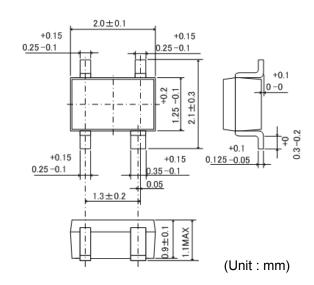


■PACKAGING INFORMATION

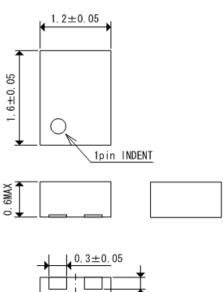
●SOT-25

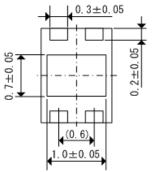
●SSOT-24





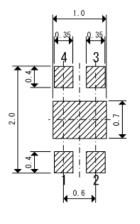
●USP-4



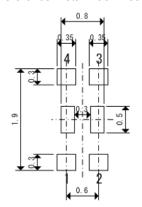


(Unit: mm)

Reference Pattern Layout

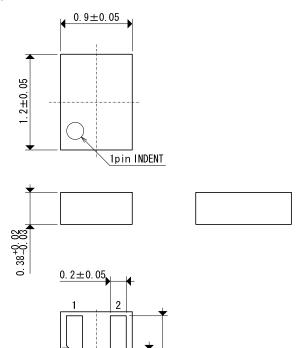


Reference Metal Mask Design

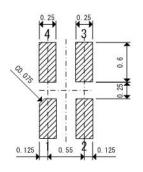


■ PACKAGING INFORMATION (Continued)

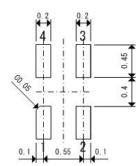
●USPN-4



Reference pattern Layout

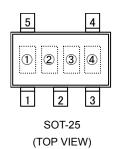


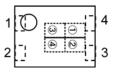
Reference metal mask design



■MARKING RULE

●SOT-25 & USP-4





USP-4 (TOP VIEW)

1 represents product series

MARK	PRODUCT SERIES
С	XC6213xxxxxx

23 represents type of regulator

	MA			
VOLTAGE	VOLTAGE VOLTAGE		VOLTAGE	PRODUCT SERIES
=0.1~3.0V	=3.1~6.0V	=0.15~3.05V	=3.15~6.05V	
Х	В	F	М	XC6213xxxxxx

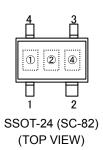
3 represents output voltage

MARK		OUTPUT VOLTAGE (V)			MARK	OUTPUT VOLTAGE (V)			
0	-	3.1	-	3.15	F	1.6	4.6	1.65	4.65
1	-	3.2	-	3.25	Н	1.7	4.7	1.75	4.75
2	-	3.3	-	3.35	K	1.8	4.8	1.85	4.85
3	-	3.4	-	3.45	L	1.9	4.9	1.95	4.95
4	-	3.5	-	3.55	М	2.0	5.0	2.05	-
5	-	3.6	-	3.65	N	2.1	-	2.15	-
6	-	3.7	-	3.75	Р	2.2	ı	2.25	-
7	-	3.8	-	3.85	R	2.3	-	2.35	-
8	-	3.9	-	3.95	S	2.4	-	2.45	-
9	-	4.0	-	4.05	Т	2.5	-	2.55	-
Α	-	4.1	-	4.15	U	2.6	-	2.65	-
В	1.2	4.2	1.25	4.25	V	2.7	-	2.75	-
С	1.3	4.3	1.35	4.35	Х	2.8	-	2.85	-
D	1.4	4.4	1.45	4.45	Y	2.9	-	2.95	
Е	1.5	4.5	1.55	4.55	Z	3.0	-	3.05	-

4 represents production lot number

0 to 9, to Z reverse character 0 to 9, A to Z repeated (G, I, J, O, Q, W excluded)

●SSOT-24



① represents integer of output voltage

MARK	VOLTAGE (V)	PRODUCT SERIES
3	3.X	XC6213B3xxNx
5	5.X	XC6213B5xxNx

2 represents decimal point of output voltage

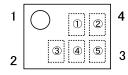
MARK	VOLTAGE	DDODUOT OFFICE	MADIC	VOLTAGE	PRODUCT
MARK	(V)	PRODUCT SERIES	MARK	(V)	SERIES
0	X.0	XC6213Bx0xNx	Α	X.05	XC6213Bx0ANx
1	X.1	XC6213Bx1xNx	В	X.15	XC6213Bx1ANx
2	X.2	XC6213Bx2xNx	С	X.25	XC6213Bx2ANx
3	X.3	XC6213Bx3xNx	D	X.35	XC6213Bx3ANx
4	X.4	XC6213Bx4xNx	E	X.45	XC6213Bx4ANx
5	X.5	XC6213Bx5xNx	F	X.55	XC6213Bx5ANx
6	X.6	XC6213Bx6xNx	Н	X.65	XC6213Bx6ANx
7	X.7	XC6213Bx7xNx	K	X.75	XC6213Bx7ANx
8	X.8	XC6213Bx8xNx	L	X.85	XC6213Bx8ANx
9	X.9	XC6213Bx9xNx	М	X.95	XC6213Bx9ANx

④ represents production lot number

0 to 9, A to Z repeated (G, I, J, O, Q, W excluded). Note: No character inversion used.

■MARKING RULE (Continued)

●USPN-4



① represents product series

MARK	PRODUCT SERIES
С	XC6213xxxxxx

2 represents type of regulator

MARK				
VOLTAGE	VOLTAGE	VOLTAGE	VOLTAGE	PRODUCT SERIES
=0.1~3.0V	=3.1~6.0V	=0.15~3.05V	=3.15~6.05V	
X	В	F	М	XC6213Bxxxxx

3 represents output voltage

MARK	OUTPUT VOLTAGE (V)		MARK	OUTPUT VOLTAGE (V)			GE (V)		
0	-	3.1	-	3.15	F	1.6	4.6	1.65	4.65
1	-	3.2	-	3.25	Н	1.7	4.7	1.75	4.75
2	-	3.3	-	3.35	K	1.8	4.8	1.85	4.85
3	-	3.4	-	3.45	L	1.9	4.9	1.95	4.95
4	-	3.5	-	3.55	М	2.0	5.0	2.05	-
5	-	3.6	-	3.65	N	2.1	-	2.15	-
6	-	3.7	-	3.75	Р	2.2	-	2.25	-
7	-	3.8	-	3.85	R	2.3	-	2.35	-
8	-	3.9	-	3.95	S	2.4	-	2.45	-
9	-	4.0	-	4.05	Т	2.5	-	2.55	-
Α	-	4.1	-	4.15	U	2.6	-	2.65	-
В	1.2	4.2	1.25	4.25	V	2.7	-	2.75	-
С	1.3	4.3	1.35	4.35	Х	2.8	-	2.85	-
D	1.4	4.4	1.45	4.45	Y	2.9	-	2.95	
Е	1.5	4.5	1.55	4.55	Z	3.0	-	3.05	-

45 represents production lot number

01 to 09, 0A to 0Z 11 to 9Z, A1 to A9, AA to Z9,ZA to ZZ repeated (G, I, J, O, Q, W excluded). Note: No character inversion used.

SOT-25 Power Dissipation

Power dissipation data for the SOT-25 is shown in this page.

The value of power dissipation varies with the mount board conditions. Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

Condition: Mount on a board
Ambient: Natural convection
Soldering: Lead (Pb) free

Board: Dimensions 40 x 40 mm (1600 mm² in one side)

Copper (Cu) traces occupy 50% of the board area

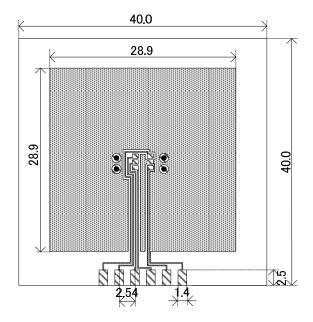
In top and back faces

Package heat-sink is tied to the copper traces

(Board of SOT-26 is used.)

Material: Glass Epoxy (FR-4)

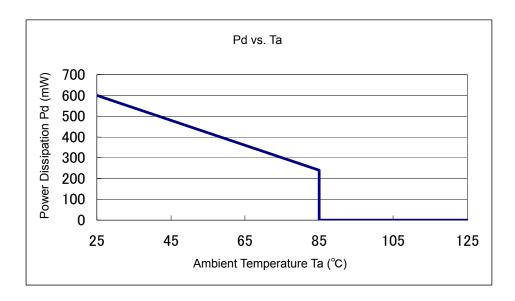
Thickness: 1.6 mm Through-hole: 4 x 0.8 Diameter



Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient temperature

Ambient Temperature (°C)	Power Dissipation Pd (mW)	Thermal Resistance (°C/W)
25	600	166.67
85	240	100.07



XC6213 Series

SSOT-24 Power Dissipation

Power dissipation data for the SSOT-24 is shown in this page. The value of power dissipation varies with the mount board conditions. Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

Condition: Mount on a board
Ambient: Natural convection
Soldering: Lead (Pb) free

Board: Dimensions 40 x 40 mm (1600 mm² in one side)

Copper (Cu) traces occupy 50% of the board area

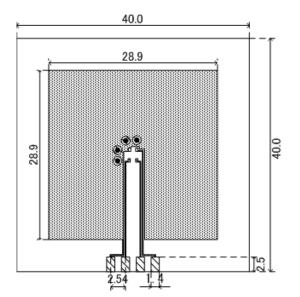
In top and back faces

Package heat-sink is tied to the copper traces

Material: Glass Epoxy (FR-4)

Thickness: 1.6 mm

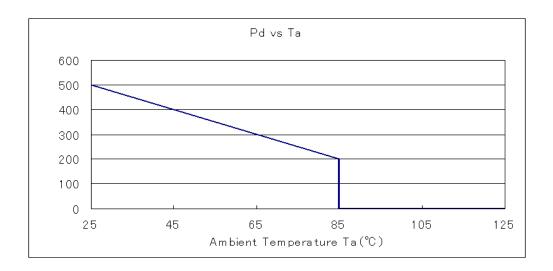
Through-hole: 4 x 0.8 Diameter



Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient temperature

Ambient Temperature (°C)	Power Dissipation Pd(mW)	Thermal Resistance (°C/W)
25	500	200.00
85	200	200.00



USP-4 Power Dissipation

Power dissipation data for the USP-4 is shown in this page. The value of power dissipation varies with the mount board conditions. Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)

Condition: Mount on a board
Ambient: Natural convection
Soldering: Lead (Pb) free

Board: Dimensions 40 x 40 mm (1600 mm² in one side)

Copper (Cu) traces occupy 50% of the board area

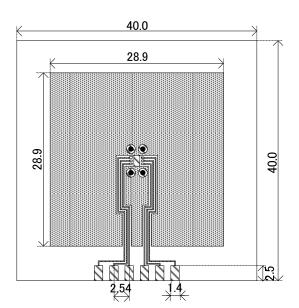
In top and back faces

Package heat-sink is tied to the copper traces

Material: Glass Epoxy (FR-4)

Thickness: 1.6 mm

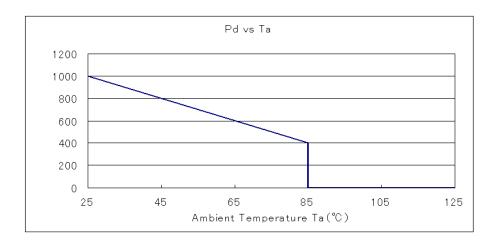
Through-hole: 4 x 0.8 Diameter



Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient temperature

Ambient Temperature (°C)	Power Dissipation Pd(mW)	Thermal Resistance (°C/W)
25	1000	100.00
85	400	100.00



USPN-4 Power Dissipation

Power dissipation data for the USPN-4 is shown in this page.

The value of power dissipation varies with the mount board conditions.

Please use this data as one of reference data taken in the described condition.

1.Measurement Condition (Reference data)

Condition: Mount on a board
Ambient: Natural convection
Soldering: Lead (Pb) free

Board: Dimensions 40 x 40 mm (1600 mm² in one side)

Copper (Cu) traces occupy 50% of the front and 50%

of the back.

The copper area is divided into four block,

one block is 12.5% of total.

The USPN-4 package has for terminals.

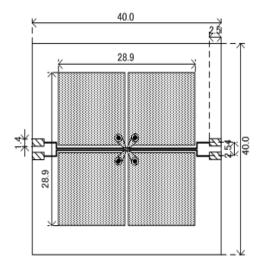
Each terminal connects one copper block in the front and

one in the back.

Material: Glass Epoxy (FR-4)

Thickness: 1.6 mm

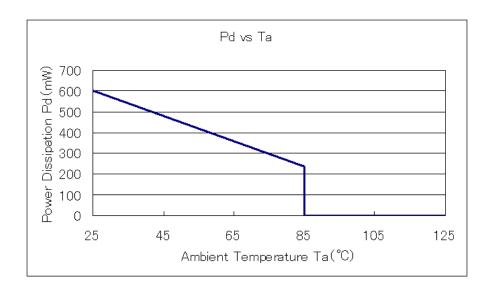
Through-hole: 4 x 0.8 Diameter



Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient temperature

Ambient Temperature (°C)	Power Dissipation Pd(mW)	Thermal Resistance (°C/W)	
25	600	166.67	
85	240	100.07	



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